

BCR08ES-14A

700V - 0.8A - Triac

Low Power Use

R07DS0971EJ0001

Rev.0.01

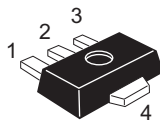
Nov 28, 2012

Features

- $I_{T(RMS)}$: 0.8 A
- V_{DRM} : 700 V
- I_{FGTL} , I_{RGTL} , I_{RGTHI} : 5 mA or 10mA
- □mode trigger is available (#B11, #B12)
- Non-Insulated Type
- Planar Passivation Type
- Surface Mounted Type
- Completed Pb Free

Outline

RENESAS Package code: PLZZ0004CA-A)
(Package name: UPAK)



1. Gate Terminal
2. T₂ Terminal
3. T₁ Terminal
4. T₂ Terminal

Applications

Hybrid IC, solid state relay, electric fan, washing machine, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		14	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	700	V
Non- repetitive peak off-state voltage ^{Note1}	V_{DSM}	840	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	0.8	A	Commercial frequency, sine full wave 360° conduction, Ta= 40°C ^{Note3}
Surge on-state current	I_{TSM}	8	A	60 Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	I ² t	0.26	A ² s	Value corresponding to 1 cycle of half wave 60 Hz, surge on-state current
Peak gate power dissipation	P_{GM}	1	W	
Average gate power dissipation	$P_{G(AV)}$	0.1	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	0.5	A	
Junction temperature	T _j	- 40 to +125	°C	
Storage temperature	T _{stg}	- 40 to +125	°C	
Mass	—	50	mg	Typical value

Electrical Characteristics

Parameter	Symbol	BCR08ES-14A#B10		BCR08ES-14A#B11		BCR08ES-14A#B12		Unit	Test conditions	
		Min.	Max.	Min.	Max.	Min.	Max.			
Repetitive peak off-state current	I_{DRM}	—	1.0	—	1.0	—	1.0	mA	$T_j = 125^\circ\text{C}$ V_{DRM} applied	
On-state voltage	V_{TM}	—	2.0	—	2.0	—	2.0	V	$T_c = 25^\circ\text{C}$, $I_{TM} = 1.2\text{ A}$ instantaneous measurement	
Gate trigger voltage ^{Note2}	I	V_{FGTI}	—	2.0	—	2.0	—	2.0	V	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$ $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	V_{RGTI}	—	2.0	—	2.0	—	2.0	V	
	III	V_{RGTIII}	—	2.0	—	2.0	—	2.0	V	
	□	V_{FGTIII}	—	—	—	2.0	—	2.0	V	
Gate trigger current ^{Note2}	I	I_{FGTI}	—	5	—	5	—	10	mA	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$ $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II	I_{RGTI}	—	5	—	5	—	10	mA	
	III	I_{RGTIII}	—	5	—	5	—	10	mA	
	□	I_{FGTIII}	—	—	—	7	—	10	mA	
Gate non-trigger voltage	V_{GD}	0.2	—	0.2	—	0.2	—	V	$T_j = 125^\circ\text{C}$ $V_D = 1/2 V_{DRM}$	
Thermal resistance	$R_{th(j-a)}$	—	65	—	65	—	65	$^\circ\text{C/W}$	Junction to ambient ^{Note3}	
Critical-rate of rise of off-state commutating voltage ^{Note4}	$(dv/dt)_c$	0.5	—	0.5	—	0.5	—	V/ μs	$T_j = 125^\circ\text{C}$	

Notes: 1. Gate open.

2. Measurement using the gate trigger characteristics measurement circuit.

3. Soldering with ceramic plate (25 mm × 25 mm × t0.7 mm)

4. Test conditions of the critical-rate of rise of off-state commutating voltage are shown in the table below.

Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = -0.4\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
UPAK	SC-62	PLZZ0004CA-A	UPAK / UPAKV	0.050g	

The drawing shows three views of the package: a top view, a side view, and a bottom view. The top view shows a rectangular package with a diameter of 4.5 ± 0.1 mm. The width of the top flange is 1.8 Max mm. The height of the top flange is 0.4 mm. The diameter of the central hole is $\phi 1$ mm. The distance from the center of the hole to the edge of the top flange is 2.5 ± 0.1 Max mm. The total height of the package is 4.25 Max mm. The distance from the bottom of the package to the top of the top flange is 0.8 Min mm. The distance between the two mounting tabs is 3.0 mm. The width of each mounting tab is 1.5 mm. The distance from the center of the hole to the edge of the mounting tabs is 0.53 Max mm and 0.48 Max mm. The side view shows a height of 1.5 ± 0.1 mm and a width of 0.44 Max mm. The bottom view shows a width of 1.5 mm and a distance of 0.4 mm from the center of the hole to the edge of the mounting tabs. The distance between the two mounting tabs is 0.2 mm.

Ordering Information

Orderable Part Number	Packing	Quantity	Remark
BCR08ES-14AT14#B10	Embossed Tape	4000 pcs.	Taping direction "T1"
BCR08ES-14AT14#B11	Embossed Tape	4000 pcs.	Taping direction "T1"
BCR08ES-14AT14#B12	Embossed Tape	4000 pcs.	Taping direction "T1"

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